U nusual therm oelectric behavior of packed crystalline granular m etals

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Abstract

Loosely packed granular materials are intensively studied nowadays. Electrical and them altransport properties should reject the granular structure as well as intrinsic properties. We have compacted crystalline CaAlbased metallic grains and studied the electrical resistivity and the therm oelectric power as a function of temperature (T) from 15 to 300K. Both properties show three regimes as a function of temperature. It should be pointed out:

(i) The electrical resistivity continuously decreases between 15 and 235 K (ii) with various dependences, e.g., T 3=4 at low T, while (iii) the therm oelectric power (TEP) is positive, (iv) shows a bump near 60K, and (v) presents a rather unusual square root of temperature dependence at low temperature. It is argued that these three regimes indicate a competition between geometric and thermal processes, – for which a theory seems to be missing in the case of TEP. The microchemical analysis results are also reported indicating a complex microstructure inherent to the phase diagram peritectic intricacies of this binary alloy.

I. IN TRODUCTION

There are dierent types of dense granular materials, i.e. those in which grains are dispersed in a solid matrix in contrast to loosely packed granular materials. The former class is necessarily a random mixture of two ormore phases with dierent I V characteristics. It has been much investigated from a fundamental point of view along the lines of percolation ideas, for example to search in the case of superconducting embedded networks [1] for the so called critical concentration, whence percolation critical exponents, etc. [2,3]. In the second class, the mixture can be a powder of even a single chemical type of grains. This class, containing wet or dry mixtures, is of interest for the technological questions they raise like for powder, sand or pill packings [4,5]. In between, stem the loosely packed colloid deposits and polymer like composites [6,7].

Depending on the volume fraction they occupy, powders can be more or less dense. They can be distinguished from a mechanical or optical point of view, i.e. according to the surface deformation upon loading [8] or to the modi cation of the absorbing spectrum [9{12] (recall "invisible" U2 planes). In the case of electrically insulating grains, recall that structural properties, e.g. of sand or rice piles are much studied [4,5]. The thermal properties, like the heat capacity and the thermal conductivity, e.g. of sand, are of interest as well.

The electrical properties of such systems are also of interest when the grains are metallic-like [13]. It is thought that there is a strong modi cation of the interface, when an electric current is im posed, -leading to a strong modi cation of the oxide layers formed at the grain surfaces [14{16}], -a modi cation going even up to welding. This the Calzecchi-Onesti transition [17] leading to sharp transitions, in the i V characteristics, when the current reaches a certain value at which the resistance falls several orders of magnitude. Microsolderings between grains may occur before a Calzecchi-Onesti transition [18], just like nucleation sites are initiated by high concentration gradients at a retorder phase transition. Those solderings are non equilibrium, or irreversible processes thereby being the fundamental cause for the hysteretic behavior found in i V curves of granular packing. In the case of not

too good conductors, this leads to the study of hot spots, equally detrimental in superconducting devices [19]. There are very few papers dealing with the temperature dependence of such electrically conductive (loosely) packed materials, - none to our knowledge about the therm oelectric power temperature dependence.

In huge contrast, studies of the electrical resistance R (T) of inhom ogeneous composites have been of continuing interest [20,21], with much emphasis on low temperature phenomena, because of superconductivity [22{24}] and tunneling electric eds; e.g. see [25{28}] and references therein. Interestingly, the thermoelectric power Q (T) has been measured in ceramics, like alumina or SiG elloys [29,30] and composite superconductors.

It is fair to mention for completeness a few papers on glassy systems [31{35], -although these are not truly packed systems, but are nevertheless close to ... closed packed con gurations.

Except for insulating glasses, most composite systems are often made of electrically conducting grains embedded in an insulator matrix, thus behave like a disordered system in the (usually) localized regime. Transport properties depend whether or not the system is above a percolation transition or not; they are usually dominated by carrier hopping between grains, i.e. an intergrain process. Thus they display certain features of the variable range-hopping (VRH) phenomenon type observed in doped semiconductors in fact. In particular, the electrical resistivity of such systems has been observed to obey a so called a stretched exponential dependence,

$$(T) = {}_{0} e^{\left[\left(\frac{T_{0}}{T}\right)^{p}\right]}; \qquad (1)$$

where T is the tem perature, T_0 a characteristic tem perature, and p = 1 = (d + 1), in term s of d the dim ensionality of the system [36{38}].

Yet, it seems obvious that from both structural and chemical points of view, the dense but loosely packed granular systems should be quite dierent from doped materials. In a (loosely or not) packed granular system, the metal (or conducting entity) occupies a nite volume in space, and hopping from a grain to a (nearest neighbor) grain is likely to occur

through rather wide and often inhom ogeneous insulating barriers with nite thickness distributed over a sort of percolating network [2,14,15,39,40].

In contrast, in the case of a doped material, hopping between two impurity sites goes through only a narrow size insulating hom ogeneous barrier.

Therefore, some debate may arise on whether the VRH model of doped materials can be applied to granular (loosely or densely) compacted metals. The more so for the therm celectric power (TEP) or Seebeck coecient which is a much more elusive quantity [4143] and does not seem to be found when browsing through the VRH literature. Whence the main motivation behind our studies.

Such electrical and them all transport properties may be depending on many conditions, like various types of grain size distributions. This opens up a huge set of problems, -which cannot be all tackled here. The electric conductivity and them oelectric power in such composite systems can be enhanced or reduced, - the more so as a function of temperature when there are competitive processes. At this stage it should be pointed out references based on macroscopic points of view, with considerations based on electric properties depending on the type of packing as in [44{53}] to quote a few about the (electric power, see [54{57}].

In conclusion of the above, it is clear that some attention should be focussed on the possible competition between geometric and thermal in uence with some subsequent interpretation based on electronic fundamentals.

A simple binary alloy Ca_xAl_y was selected as an interestingly representative system. The phase diagram is partially known since 1928 according to [58]. It was studied when attempting to make crystals from systems which were initially glassy. Previous investigations did not report any crystalline phase characteristics, nor a fortiori temperature dependent properties of crystalline packed grains.

As described in Sect. 2, an original route has been used for the synthesis of C aA l_2 ; we have obtained tiny crystals $(0.5m \text{ m})^3$. A fler compacting the granular material, we have measured the electrical resistivity (), therm oelectric power (Q) and magnetic properties as

a function of tem perature (Sect. 3), from 40 to 300 K or so. The tem perature dependences of and Q are found to be unusual. The magnetic susceptibility behavior is paramagnetic (Sect. 3). The noting interpretation relies on temperature dependent percolation network features, and stresses intergrain and intragrain dierences occurring in such granular packed materials. Band structure considerations from Huang and Corbett [59] on related Ca_xAl_y , with various x and y, are taken into account in view of interpreting our notings (Sect. 4). The last section (Sect. 4) serves as much as a place for conclusion as for raising questions and suggesting further investigations. The chemical characteristics of the grains are found in Appendix.

II. SAM PLE SYNTHESIS AND CHEM ICAL CHARACTER IST ICS

Several C a_xAl_y phases and stoichiom etric compounds are known [58]. Recently Huang and Corbett [59] synthesized several of these and characterized them, e.g. C $a_{13}Al_{14}$ and C a_8Al_{13} , from an electrical resistivity point of view, including some calculation and discussion of the band structure of both compounds. Both materials were found to be good electrical conductors, $_{RT}$ '55 and '60 om respectively (with paramagnetic Pauli properties). Huang and Corbett [59] conclude on a very similar density of states near the Fermilevel.

Our choice of the x and y values for our study has been in uenced by observing the similarity of the C a_xAl_y phase diagram with that of B iSrC aCuO or YB aCuO superconducting
ceram ics, i.e. a peritectic point near x=1 and y=2, a compound not studied in the
crystalline phase to our knowledge. It is expected that the phase diagram analogy could
be of interest for interpreting features, taking into account the grain intrinsic property, if
necessary.

M aster alloys were prepared in an arc furnace under spectrally pure argon atmosphere with a 0.2 MPa overpressure. Titanium getter was used in order to eliminate traces of oxygen originating from calcium. The purity of starting metals was 5N and 3N for Aland

Ca, respectively. Sam ples were hom ogenized for 15 m inutes at 1420 K.

The sample is made of very tiny black but shining grains. Even though no size dispersion distribution was looked for, the size of the grains seems to be rather uniform, from visual observation, and of the order of $(0.5 \text{m m})^3$. The samples are very brittle even after strong packing in a classical press. A fter metallographic treatment of the sample surfaces, a grain content is seen through a high resolution polarized light microscope (Fig. 1) to be made of dendrites embedded in a matrix, the dendrite long size roughly ranging between 10 and 50 m. A las it has been impossible to extract the needles from the matrix. The dendrites are Alrich and made of CaAl while the matrix is Alpoor and has a composition close to Ca_{0.6}Al_{0.4}. The chemical characteristics and a comment on the grow process, whence the grain structural (unavoidable) inhomogeneity, can be found in the Appendix. It is shown that the grains are crystalline.

III.M EASUREM ENTS

A . E lectrical R esistance

The four-probe m ethod was used for precise m easurem ents of the electrical resistance of the sam ples. A dc current up to 10 m A was injected as one second pulses with successively reversed direction in order to avoid Joule and Peltier e ects [60,61] and ageing [14]. The electrical resistivity was calculated from the voltage drop and the sam ple dimensions, i.e. $7 \times 10 \text{ m m}^3$. The tem perature was varied between 20 and 300 K in a closed cycle refrigerator with stabilization by a LS340 controller with accuracy of 0.01 K. See other details elsewhere [62].

The electrical resistance versus temperature variation R (T) measured in a broad temperature range is shown in Fig. 2 and present three regimes. Dierent unusual features can be observed. First of all R decreases with e T from 20 K down to 235 K, in particular there is a quasi linear decay between 70 and 235 K.On a log-log plot (Fig. 3) we observe that R

rem arkably well behaves like $T^{3=4}$ for 15 K < T < 70K.R (T) seems to remain rather constant for higher T, or slightly increasing above 235 K. The electrical resistivity is about = 100 cm at room temperature.

B. Therm oelectric power

The therm oelectric power (TEP) has been measured following the method described in Ref. [61]. The imposed temperature gradient is about 1 K/cm. The results are shown in Fig. 4 as Q vs:T.Q(T) is positive in the investigated temperature range and about 20 V=K at 77K and 40 V=K at room temperature respectively, -values similar to those of poorly metallic systems. The data presents a bump at ca. 60 K followed by a minimum at 100 K and a rapid rise thereafter (0.12 V=K^2). In Fig. 5, a $\ln (Q=T) \text{ vs } \ln (T)$ plot is shown in which a triple regime is well observed. Below 60 K, Q(T)=T' $20=\frac{p}{T}$, thus Q(T)' $20.0 \text{ T}^{0.5}$. In the intermediary regime, the decay is very regular till 100 K. Above 100 K, the slope is equal to -0.25 on such a $\log \log p$ lot, indicating that Q(T) behaves like $T^{3=4}$, thus not quite linearly as it should be usual form etallic systems at high T.

C . M agnetic susceptibility

DC magnetic measurements at several temperatures (20 to 300 K) and magnetic elds (up to 1T) were also performed in a Quantum Design Physical Property Measurement System, when it worked, using an extraction method.

The response of the material is that of a paramagnetic one over the whole temperature range investigated, with a susceptibility of the order of 8.6 10^{-6} (SI units) at T = 300K. It is quasi-independent of temperature: the susceptibility decreases by a factor of 3 between 50 K and 300K, in a eld of 1 T, but this is not displayed here.

IV . D ISC U SSIO N

The discussion is essentially based on the microstructure optically and microscopically observed, i.e. a packed mixture of (apparently heterogeneous, see Appendix) tiny grains, together with the unusual temperature dependence of the electrotherm alproperty for stressing the features and emphasizing fundamental considerations.

First, let it be observed that even though each grain is surely multiphasic, see Appendix, both phases, according to Huang and Corbett [59] have equivalent electrical (metallic) properties. Therefore for discussing the electrical resistivity, at least, we can safely assume that each grain is monophasic and metallic. If the grains were made of insulating components in a not well conducting matrix, thus having a peculiar heterogeneity as found in metal-insulator composites, one might argue that charging elects on inner surfaces might complicate the analysis. This does not seem to be the case here, whence giving some validity for elective medium theory considerations in describing each grain.

One might next wonder whether the sample network structure could be much modied as a function of temperature, leading to a temperature dependent (macrostructural) transition. Even though we cannot entirely disregard such elects due to grain thermal expansions, we assume that the granular network structure, whence the number of contacts should be rather stable. However the intergrain connections could be temperature dependent. Therefore the electrical conduction process should be only resulting from a intergrain hopping process and an intragrain (metallic like) conductivity. Both having a dierent temperature dependence. A gain, an elective medium theory should be valid.

A . E lectrical R esistance

Various mechanisms are invoked when explaining a decreasing R (I) behavior: (i) an Arrhenius excitation, i.e. an exponential decrease corresponding to a therm albarrier leakage when the temperature increases; (ii) a Mott, so called variable range hopping (VRH) [36,37]

m echanism, or (iii) a Shklovskii-E fros (SE) e ect [38,63], i.e. a smallCoulomb gap opens up at the Ferm i surface as a result of Coulomb interactions between the quasiparticle carriers, thereby modifying MottVRH result. In these cases the electrical resistivity can be expressed as a stretched exponential

$$(T) = {}_{0} e^{\left[\left(\frac{T_{0}}{T}\right)^{p}\right]};$$
 (2)

where $_p$ is a m aterial weakly T dependent quantity, and p=1/4 or 1/2 for the M ott or SE type conductivity; T_0 characterizes the variable range hopping energy scale. The classical Arrhenius law corresponds to p=1. Plots of \log vs. T $^{1=2}$ or T $^{1=4}$ look so far from any straight line that they are not displayed; they do not indicate any (relatively extended) linear region which could convince us of arguing in favor of a M ott or SE m echanism in some range. In fact it is found from Fig. 6, that below 70 K

$$(T) = _0 (\frac{T}{77})^{-3=4};$$
 (3)

with $^{\circ}_{0}$ = 25 cm when T is measured in Kelvin.

Unusual fractional exponents are often interpreted in other condensed matter research through fractal considerations for the underlying (geom etrical) network supporting the elementary excitations of interest [64], – them selves having a possible tem perature dependence (which scales like their intrinsic interaction energy). Recall here as an analogy the case of magnetic disordered sytems, characterized by some exchange energy J (and some directly related) critical temperature $T_{\rm c}$, on a (random) network, characterized by some fractal dimension. The best description of those systems is in fact [65] through two difference lengths, $_{\rm g}$ and $_{\rm T}$, one (usually temperature independent) for the network, one (strongly temperature dependent) for the magnetic structure.

The present electrical conduction process with the tem perature behavior of (T), i.e. the $T^{3=4}$ law is best interpreted in terms of a similar argument covering the whole tem perature range. In particular, the power law $(T^{0.75})$ resistance decrease can be thought to result from a thermale ect, on a resistive (geometrically disordered) backbone, not changing with

tem perature in this low T range. Indeed in presence of such a geometric disorder, the charge carrier mean free path 'can be considered in the usual linear superposition approximation as [41]

$$\frac{1}{\gamma} = \frac{1}{\gamma_T} + \frac{1}{\gamma_G} \tag{4}$$

where $'_T$ and $'_g$ are the mean free path of carriers respectively due to (grain size limited) therm alle ects and intrinsic geometric disorder. Moreover, in this less conducting, i.e. low temperature regime, 0 rbach description of random media excitations, [64] can be used to interpret the exponent 3=4 as the signature of the percolation network for the hopping charge carriers, -whence inding a (very reasonable) elective (fractal-like [64,65],) dimensionality '' = 9=4 of the three dimensional, since '' > 2, backbone [66].

The 60-70 K break (or crossover) indicates the energy range at which the therm alprocess takes over on the geometric disorder. From a microscopic point of view, this temperature value allows us to estimate the (average) electrical carrier energy distance between the Fermi level and the bottom (observe that Q (T) > 0, in Fig. 7) of the conduction band. This hopping (or barrier) energy being overcome at such a temperature, leads to a more easy conduction process, whence a weaker . Moreover, above such a T, in the so called intermediate temperature range the R (T) linear decay reminds us of the behavior found in heavy fermion systems. Indeed an electrical resistivity decreasing with temperature, as in Fig. 5, is also observed in heavy fermion materials [67{69}]. Such a feature is associated to a sharp DOS near the Fermi level and carrier (de) localization [70].

Finally, at higher tem perature, the smooth decay of R (T) with increasing T can be attributed to the Ferm i-D irac function behavior increasing width as T increases and further charge carrier delocalization [70]. The electron (or rather hole, here) band m ass contains a more important imaginary contribution as a function of temperature, and the charge carrier wave function spreads out. The intergrain thermally activated charge (ballistic) hopping process. becomes more pronounced at high temperature and competes with (p-like) metallic conduction in the grains. Recall a similar type of mechanism due to (dense)

granular structure in m ixed superconductors [1,27,71] like A HG e m ixture, at "not very low tem peratures" [72] where the R (I) decay is like T 0:117, an exponent similar but quite di erent from 3=4. A ssum ing that all (weak) localization e ects are suppressed by the tem perature the occurrence of a phase transition in R (I) exists depending on the tunneling conductance g, and the phase coherence on both sides of the tunneling junction. For such system s, at small g the conductivity exponentially decays with tem perature, but has a logarithm ic tem perature dependence at large g. This (e ective) conductance picture can be used analogously here, since the intergrain barrier conductance g likely increases with tem perature. However the tem perature dependences found here above are quite di erent from those in the granular m etals discussed by e.g. E fetov and T schersich [27]. In fact, in view of the di erent tem perature dependences, we prefer to consider that the e ects are due to intrinsic density of states rather than m obility constraints at not too low tem perature.

B. Therm oelectric power

Turning to the TEP data, we have already argued elsewhere [73] that Q should be considered as a transport coe cient and not assim ilated only to the change in entropy or density of states [41]. Nevertheless the above recalled considerations on mean free path selection for the electrical charge carrier scattering processes are also very useful in order to interpret the Q (T) behavior at low T. As in an elective medium approximation, the behavior of Q (T) depends on the dominant scattering process. Notice that the concept of a percolation network made of tunneling barriers with a distribution of temperature gradients is not usual noneasily simulated for TEP. However see some similar consideration by D anilov et al. in [66].

Let us also recall that a TEP m easurement implies no external electrical current. Whence it is unlikely that some "barrier ageing" or "hot spots" take place in the tem perature range of interest through a Calzecchi-O nesti-like transition [17]. Moreover local charging can also be neglected, in view of the metallic nature of the grains, -though local hot spots might exist.

To our know ledge they have not been observed in such con gurations. Thus within the above line of thought, both increase in charge and heat transport as a function of tem perature and the large them coelectric e ect at room tem perature can also be understood to result from a delocalization process on the complex barrier network, with two competing characteristic mean free paths, and a wakening of the contact TEP due to Ferm i surface widening with temperature. There is to our knowledge no such a theory for TEP.

To be fair one m ight also argue on whether the N -shape of Q (T) is not due to a phonon drag. Our argument to dism is sphonon drag in favor of competing carrier localization lengths stems in the fact that phonon drag is usually associated to long wave length phonons and are thus sensitive mainly to boundary scattering. In view of the grain size and granular packing, it could be the case here. However, phonon drag description leads to a predicted behavior like T^3 for metallic systems, - this is not found here at all. In an argument, recall that TEP of compacted small size (1 mm) homogeneous Ge grains has been previously studied at low temperature, without any convincing evidence that the behavior was due to phonon drag [74{76}. In fact, a Q T^{9-2} should be expected [77], a very dierent behavior from what is observed here. Whence it can be discounted that the peak in TEP is due to phonon drag processes. We thus propose that the features are due to an intrinsically competitive (geometric-thermal) dissipation mechanism, involving intra and intergrain parameters. Both a change in DOS and/or electronic heat conduction scattering should be taken into account in theoretical work [41].

V.CONCLUSION

A fler studying the e ect of electrical currents on intergrain barrier ageing, at a xed (room, in fact) temperature for loosely but dense packing [14{16}], one step, among many others, consists in studying the temperature depedence of basic transport properties, like the electrical resistivity and the therm oelectric power. One might wonder whether features are due to the packing structure only or whether the electrotherm all properties are sensitive

to grain contacts.

We have synthesized a packing of grains made of well identied crystalline phases [59]. The microstructure and chemical content of the tiny grains have been examined. We have measured the electrical resistivity and the therm oelectric power.

The therm oelectric power shows three regimes, like the electrical resistivity, – in both cases within identical temperature intervals. Readily the electrical resistivity has a long unusual power law decreasing regime between 20 and 200 K. In particular, the therm oelectric power shows an unusual square root temperature dependence at low temperature. It seems that the observed complex dependences can be considered to result from a competition between metallic intragrain and semiconducting intergrain barrier properties.

From our observations and reported features by others, we can neglect the inhom ogeneity of the grains when discussing electrical and therm all transport properties. The system is thus thought to be described as a network of resistive packed "m acro" grains having boundaries well connected between conducting grains. The role of the density of carriers in the grains is emphasized. Indeed in view of the rather high value of the overall resistance, even taking into account the elect of "m acro" grain barriers, a sharp density of states (DOS) at the Ferm i level, close to some conducting gap, m aybe expected, suggesting some localization. Thus such electrical and therm all transport properties indicate a competition between mean free paths, later overcome by easy electronic tunneling.

We stress that the corresponding features in the temperature regimes both for R (T) and Q (T) allows for strong arguments on the physics of such packed granular metallic material properties. The R (T) behavior, $T^{3=4}$ at low temperature followed by a linear decrease being unusual for good metallic systems is interpreted as resulting from a competition process between intragrain and intergrain conductivity. At low temperature we suggest an intergrain limiting conductivity with intragrain electronic localization and intergrain mediated hopping. An increase in temperature leading to a (low) saturation and delocalization regime.

From the resistance data break we can even conjecture the existence of a small gap (

60 K, between the E_F level and the top of the valence band, in C aA l_2 , such that therm all excitations reduce the number of truly conducting electrons by exciting them into a narrow (heavy mass) conduction band. This suggests the great interest in calculating the band structure of such compound (s); this could be complemented by specic heat and optical measurements.

Second it is necessary to insist about the unusual square root dependence of the therm oelectric power at low temperature, $Q = T^{1-2}$, and $Q = T^{3-4}$ at high temperature. Under the conjecture that the behavior is consistent with an electronic hopping between grains at low temperature, we thus report for the rest time the behavior of a charge carrier on a percolation network under a temperature gradient. A search of the literature has not revealed whether this TEP behaves like that in glasses [31,32] or cern ets, nor indicates a behavior controlled by grain size e ects [77]. Therefore in agreement with the above considerations on R (T) it may be concluded that such a behavior represents (as observed for the rest time maybe here) a granular conducting medium therm celectric power.

An intersting point of be raised here is whether a Peltier e ect and a Seebeck e ect are equivalent [78] in granular materials, e.g. would not spots and aging occur, leading to some hysteresis, if rather than a temperature gradient (Seebeck con guration) a potential dierence (Peltier con guration) is applied, and the temperature gradient next measured in order to obtain the TEP characteristics. This is an open question.

In conclusion, there is often some question about whether single crystals are the only samples of fundam ental interest, to be studied and reported upon. No doubt that they easily bring some information on microscopic parameters. Yet, it is also often shown that polycrystalline samples are useful when nemeasurements are performed. Moreover, properties of packed systems receive some attention now adays. To explain their properties become a challenge in condensed matter. In fact we report an unusual decay of the electrical resistance with temperature, a square root of temperature dependence for the TEP, at low T and some consistent temperature ranges where phenomena can be distinguished due to microscopic processes in metallic grains.

A ppendix

An EDX analysis of the synthesized grains indicates that the dendrites (Fig. 1) are Alrich and made of CaAl₂ while the matrix is Alpoor and has a composition close to Ca_{0.6}Al_{0.4}, – in fact a mixture of Ca₁₃Al₁₄ and Ca₈Al₃, taking into account the Huang and Corbett report [59] and a very recent [79] phase diagram report sketched in Fig. 6. An X-ray diraction analysis (Fig.7) proves that there are in fact three crystalline phases. For identifying the Ca₈Al₁₃ and Ca₁₃Al₁₄ data from JCPDS less were used. From the X-ray data, the lattice parameter of the CaAl₂ phase is found to be a = 0.8.045 nm, larger than the one reported as equal to a = 0.8038 nm in ref. [58]. According to JCPDS 75-0875, a = 8.02A with Fd-3m as space group. The presence of three phases likely indicates some slight Ca excess in the initial powder.

A comment is here in order for explaining the growth process, -indeed somewhat analogous to the superconducting ceram ics mentioned above. Starting from a stoichiometric powder composition close to CaA $_{12}$, we consider that the solidication (quenching) process induces the appearance of CaA $_{12}$ grains embedded in a uid phase. Under further cooling the latter solidies, Ca $_{13}$ A $_{14}$ precipitates near (or on) CaA $_{12}$ grains and decomposes at the 850 K peritectic temperature into a Ca $_{13}$ A $_{14}$ and a Ca $_{8}$ A $_{19}$ composite matrix leading to the microstructure schematically described in Fig. 8. In so doing one can understand that large CaA $_{12}$ dendrite grains may be covered by a tiny Ca $_{13}$ A $_{14}$ layer, all embedded in a mainly Ca $_{0.6}$ A $_{19.4}$ matrix containing tiny, - less than 1 m size from optical observation, Ca $_{8}$ A $_{19}$ and Ca $_{13}$ A $_{14}$ precipitates. It is interesting to notice that the grains are made of needles in a matrix, in contrast to the rather spherical 211 particles in the 123-YBCO matrix.

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REFERENCES

- [1] G.Deutscher, O.Entin-Wohlman, S.Fishman, and Y.Shapiro, Phys.Rev.B 21, 5041 (1980)
- 2] S.K irkpatrick, Rev. M od. Phys. 45, 574 (1973)
- [3] J.P.C. Lerc, G.G. iraud, S.A. Lexander, and E.G. uyon, Phys. Rev. B 22, 2489 (1980)
- [4] H.J. Herrmann, J.P. Hovi and S. Luding, Physics of dry granular media, (Kluwer, Dordrecht, 1998).
- [5] J. Duran, Sands, Powders and Grains, (Springer, Berlin, 1999).
- [6] B.V.Derjaguin, Theory of stability of colloids and thin lms, (Consultants Bureau, New York, London, 1989).
- [7] A.G adom skiand JM.Rub, Chem. Phys. 293, 169 (2003).
- [8] H. Hertz, J. Reine und Angewandte Mathematik 92, 156 (1895).
- [9] A J. Hunt, T R. Steyer, and D R. Hu man, Surf. Sci. 36, 454 (1973).
- [10] D. Stroud and F. P. Pan, Phys. Rev. B 17, 1602 (1978).
- [11] JM . Gerardy and M . Ausloos, Phys. Rev. B 25, 4204 (1982).
- [12] P.C lippe and M. Ausloos, Phys. Stat. Sol. B 110, 211 (1982).
- [13] I. Runge, Z. Tech. Phys. 6, 61 (1925).
- [14] S.Dorbolo, M. Ausloos, and N. Vandewalle, Appl. Phys. Lett. 81, 936 (2002)
- [15] S.Dorbolo, M. Ausloos, and N. Vandewalle, Eur. Phys. J. B 34, 201 (2003)
- [16] S.Dorbolo, M. Ausloos, and N. Vandewalle, Phys. Rev. E 67, 040302 (R) (2003).
- [17] T. Calzecchi-O nesti, Il Nuovo Cimento 16,58 (1884).
- [18] S.Dorbolo, M. Ausloos, N. Vandewalle, and M. Houssa, J. Appl. Phys. 94 7835 (2003).

- [19] M. Ausloos, Physica B 108, 969 (1981).
- [20] B. Abeles, P. Sheng, M. D. Coutts, and Y. Arie, Adv. Phys. 24, 407 (1975),
- [21] J.A.A.J. Perenboom, P.W yder, and F.M eier, Phys. Rep. 78, 173 (1981).
- [22] A. I. Voitenko and A. M. Gabovich, Phys. Solid State 41, 1598 (1999).
- [23] G. G. N. Angilella, R. Pucci, F. Siringo, and A. Sudbo, in Symmetry and Pairing in Superconductors ed. by M. Ausloos and S. Kruchinin (Kluwer Academic Publishers, Dordrecht, 1999).
- [24] B. Zeim etz, N. A. Rutter, B. A. G. lowacki, and J.E. Evetts, Supercond. Sci. Technol. 14, 672 (2001).
- [25] T.C. Choy and A.M. Stoneham, J. Phys.: Cond. Matt. 2, 939 (1990).
- [26] A.V.Danilov, D.S.Golubev, and S.E.Kubatkin, Phys. Rev. B 65, 125312 (2002).
- [27] K.B. Efetov and A. Tschersich, Europhys. Lett. 59, 114 (2002).
- [28] I.S. Beloborodov, K.B. Efetov, A.W. Lopatin, and V.M. Vinokur, http:—arX ivprg=abs=cond mat=0304448; to be published in the Proceedings of NATO Advanced Research Workshop (St. Petersburg, 2003)
- [29] M.A.Ryan, R.M.W illiams, C.E.Allevato, C.B.Vining, C.K.Lowe-Ma, and S.B. Robie, J.Phys.Chem.Sol. 55, 1255 (1994),
- [30] C.B. Vining, W. Laskow, J.D. Hanson, R.R. Van der Beck, and P.D. Gorsuch, J. Appl. Phys. 69, 4333 (1991),
- [31] N.T. Kemp, A.M. Stewart, J.E. Downes, and A.B. Kaiser, J. Magn. Magn. Mater. 117-118, 129 (1998),
- [32] J.R. Cooper, Z. Vucic, and E. Babic, J. Phys. F 4, 1489 (1974).
- [33] W . A . Phillips, in Topics in Current Physics, vol. 24 Am orphous Solids: Low Temper-

- ature Properties, Ed.W.A.Phillips (Springer, Berlin, 1981)
- [34] R. Zallen The Physics of Amorphous Solids, (Wiley, New York, 1998)
- [35] R. Zeller and R. Pohl, Phys. Rev. B 4, 2029 (1971)
- [36] N. F. M. ott and E. A. D. avies, E. lectron P. rocesses in NonCrystalline M. aterials (C. larendon, O. xford, 1979)
- [37] N. F. Mott, Metal-Insulator Transitions (Taylor & Francis, London, 1990)
- [38] B. J. Shklovskii and A. J. E. fros, E. lectronic P. roperties of D. oped Semiconductors (Springer, Berlin, 1984)
- [39] D. Vandem broucq, A.C. Boccara, and S. Roux, J. Phys. III (France) 7, 303 (1997)
- [40] R. Piasecki, Phys. Stat. Sol. B 209, 403 (1998).
- [41] JM. Zim an, Electrons and Phonons (Oxford, Clarendon Press, 1962)
- [42] K. Durczewski and M. Ausloos, Z. Phys. B 85, 59 (1991); (Err.) 92, 409 (1993); K. Durczewski and M. Ausloos, Phys. Rev. B 49, 13 215 (1994); (E) Phys. Rev. B 51, 3320 (1995).
- [43] R.A.Roemer, A.MacKinnon, and C.Villagonzalo, J.Phys.Soc.Japan 72, SupplA, 167 (2003).
- [44] D. Stroud, Phys. Rev. B 12, 3368 (1975).
- [45] D. A. G. Bruggem an, Ann. Phys. Leipz. 24, 636 (1935).
- [46] J. Bernasconi and H. J. Wiesmann, Phys. Rev. B 13, 1131 (1976).
- [47] M. Horiand F. Yonezawa, J. Phys. C 10, 229 (1977).
- [48] M. Nakamura, Phys. Rev. B 28, 2216 (1983).
- [49] D. J. Bergman, J. Phys. C 12, 4947 (1977).

- [50] A S. Sangani and A. Acrivos, Proc. R. Soc. Lond. A 386, 263 (1983).
- [51] L. Poladian and R.C. McPhedran, Proc. R. Soc. Lond. A 386, 263 (1983).
- [52] A.K. Sen and S. Torquato, Phys. Rev. B 39, 4504 (1989).
- [53] A. A. Snarskii and M. Zhenirivskiy, Physica B. 322, 84 (2002).
- [54] A.S. Skal, Sov. Phys. JETP 61, 302 (1985).
- [55] T K . X ia and X C . Zeng, J. Phys. C 120, L907 (1987).
- [56] D. J. Bergm an and D. Stroud, Solid State Physics, 46, 147 (A cadem ic Press, New York, 1992),
- [57] D. J. Bergm an and L.G. Fel, J. Appl. Phys. 85, 8205 (1999).
- [58] T.B. Massalski, Binary Alby Phase Diagrams, (ASM Intl., 1990).
- [59] B. Huang and J.D. Corbett, Inorg. Chem. 37, 5827 (1998).
- [60] Ch. Laurent, S.K. Patapis, M. Laguesse, H. W. Vanderschueren, A. Rulmont, P. Tarte, and M. Ausloos, Solid State Commun. 66, 445 (1989).
- [61] H. Bougrine and M. Ausloos, Rev. Sci. Instrum. 66, 199 (1995).
- [62] M. Pekala, A. Tampieri, G. Celotti, M. Houssa, and M. Ausloos, Supercond. Sci. Technol. 9, 644 (1996).
- [63] A.L.E fros and B.L.Shklovskii, J.Phys. C 8, L49 (1975).
- [64] T.Nakayama, K.Yakubo, and R.L.Orbach, Rev.Mod.Phys. 66, 342 (1994)
- [65] D. Stau er and A. Aharony, Introduction to Percolation Theory, (Taylor and Francis, London, 1994).
- [66] A.V.Danilov, D.S.Golubev, and S.E.Kubatkin, Phys. Rev. B 65, 125312 (2002).
- [67] H. Schweitzer and G. Czycholl, Phys. Rev. Lett. 67, 3724 (1991).

- [68] B. Coqblin, in XII School of Modern Physics on Phase Transitions and Critical Phenomena, Ladek Zdroj, Poland in press
- [69] V.L.G inzburg, Physics: Uspekhi 41, 307 (1998)
- [70] P.A. Lee and T.V. Ramakrishnan, Rev. Mod. Phys. 57, 287 (1985).
- [71] S.R.Khan, E.M. Pedersen, B.Kain, A.J. Jordan, and R.P.Barber, Jr. Phys. Rev. B 61, 5909 (2000).
- [72] A. Gerber, A. Milner, G. Deutscher, M. Karpovsky, and A. Gladkikh, Phys. Rev. Lett. 78, 4277 (1997).
- [73] K. Durczewski and M. Ausbos, Phys. Rev. B 53, 1762 (1996); Err., Phys. Rev. B 54, 17224 (1996).
- [74] H.P.R. Frederikse, Phys. Rev. 92, 248 (1953).
- [75] T.H.Geballe and G.W. Hull, Phys. Rev. 94, 1134 (1954).
- [76] C. Herring, Phys. Rev. 96, 1163 (1954).
- [77] G. S. Nolas, J. Sharp, and H. J. Goldsmid, Thermoelectrics. Basic Principles and New Materials Developments (Springer, Berlin, 2001)
- [78] L.J.Anatychuk, Physics of Thermoelectricity (Inst. Thermoelectricity Kyiv, Chemivtsi, 1998).
- [79] K. Ozturk, Long-Qing Chen, and Zi-Kui Liu, J. Alloy Comp. 340, 199 (2002).

FIGURES

- FIG.1. Polarized light m icroscopy analysis of a grain of the investigated system, showing CaA l_2 dendrites, in a Ca $_{14}$ A l_{14} -Ca $_8$ A l_3 m atrix; the size of the photography diagonal is about 100 m
- FIG. 2. Electrical resistance vs. tem perature of a polycrystalline dense packed sample based on CaA $\frac{1}{2}$; the sample dimensions are 7 x 7x 10 mm 3 , leading to a resistivity at room temperature '100 cm
- FIG. 3. Same as on Fig. 2, on a log-log plot, with t to a line with slope=-3/4 at low temperature
- FIG. 4. Therm oelectric power Q (T) vs. tem perature T of a polycrystalline dense packed sample showing a N -shape behavior
- FIG.5. Same as on Fig. 4 but for Q (T)=T vs. tem perature T on a log-log plot, with ts at low and high tem perature
 - FIG. 6. Phase diagram of the binary system CaAl, extracted from ref. [76]
- FIG. 7. X-ray diagram of a dense as synthesized CaAlsystem; the inset points out to peaks belonging to the so called matrix phase
- FIG.8. Sketch of the observed m icrostructures in relation to the phase diagram of the binary compound CaAlwith emphasis on the peritectic temperature region















